

## OptiMOS®-T2 Power-Transistor

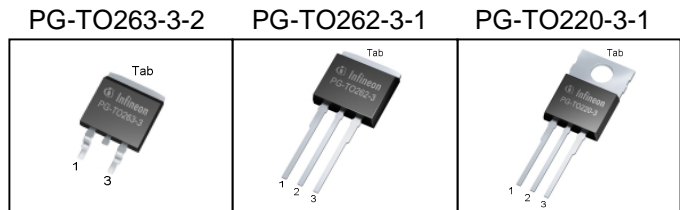


### Product Summary

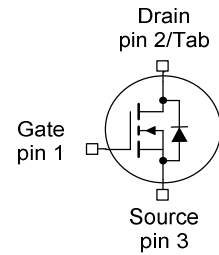
|                                |     |            |
|--------------------------------|-----|------------|
| $V_{DS}$                       | 80  | V          |
| $R_{DS(on),max}$ (SMD version) | 4.1 | m $\Omega$ |
| $I_D$                          | 120 | A          |

### Features

- N-channel - Enhancement mode
- AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested



| Type           | Package      | Marking |
|----------------|--------------|---------|
| IPB120N08S4-04 | PG-TO263-3-2 | 4N0804  |
| IPI120N08S4-04 | PG-TO262-3-1 | 4N0804  |
| IPP120N08S4-04 | PG-TO220-3-1 | 4N0804  |



**Maximum ratings, at  $T_j=25^\circ\text{C}$ , unless otherwise specified**

| Parameter                                    | Symbol         | Conditions                                      | Value        | Unit             |
|--|----------------|---|--------------|------------------|
| Continuous drain current                     | $I_D$          | $T_C=25^\circ\text{C}, V_{GS}=10\text{V}^{1)}$  | 120          | A                |
|  |                | $T_C=100^\circ\text{C}, V_{GS}=10\text{V}^{2)}$ | 108          |                  |
| Pulsed drain current <sup>2)</sup>           | $I_{D,pulse}$  | $T_C=25^\circ\text{C}$                          | 480          |                  |
| Avalanche energy, single pulse <sup>2)</sup> | $E_{AS}$       | $I_D=60\text{A}$                                | 310          | mJ               |
| Avalanche current, single pulse              | $I_{AS}$       | -   | 99           | A                |
| Gate source voltage                          | $V_{GS}$       | -   | $\pm 20$     | V                |
| Power dissipation                            | $P_{tot}$      | $T_C=25^\circ\text{C}$                          | 179          | W                |
| Operating and storage temperature            | $T_j, T_{stg}$ | -   | -55 ... +175 | $^\circ\text{C}$ |

| Parameter                                      | Symbol     | Conditions                                   | Values |      |      | Unit |
|--|------------|--|--------|------|------|------|
|  |            |  | min.   | typ. | max. |      |
| <b>Thermal characteristics<sup>2)</sup></b>    |            |  |        |      |      |      |
| Thermal resistance, junction - case            | $R_{thJC}$ | -  | -      | -    | 0.84 | K/W  |
| Thermal resistance, junction - ambient, leaded | $R_{thJA}$ | -  | -      | -    | 62   |      |
| SMD version, device on PCB                     | $R_{thJA}$ | minimal footprint                            | -      | -    | 62   |      |
|  |            | 6 cm <sup>2</sup> cooling area <sup>3)</sup> | -      | -    | 40   |      |

**Electrical characteristics**, at  $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

#### Static characteristics

|                                  |               |   |     |      |     |            |
|----------------------------------|---------------|---|-----|------|-----|------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=1mA$                          | 80  | -    | -   | V          |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=120\mu A$                 | 2.0 | 3.0  | 4.0 |            |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=80V, V_{GS}=0V$                       | -   | 0.03 | 1   | $\mu A$    |
|                                  |               | $V_{DS}=80V, V_{GS}=0V, T_j=125^\circ C^{2)}$ | -   | 10   | 200 |            |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=20V, V_{DS}=0V$                       | -   | -    | 100 | nA         |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=10V, I_D=100A$                        | -   | 3.8  | 4.4 | m $\Omega$ |
|                                  |               | $V_{GS}=10V, I_D=100A, \text{SMD version}$    | -   | 3.5  | 4.1 |            |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Dynamic characteristics<sup>2)</sup>**

|                              |              |  |   |      |      |    |
|------------------------------|--------------|--|---|------|------|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0V, V_{DS}=25V,$<br>$f=1MHz$                   | - | 4850 | 6450 | pF |
| Output capacitance           | $C_{oss}$    |  | - | 1870 | 2490 |    |
| Reverse transfer capacitance | $C_{rss}$    |  | - | 100  | 200  |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=40V, V_{GS}=10V,$<br>$I_D=120A, R_G=3.5\Omega$ | - | 20   | -    | ns |
| Rise time                    | $t_r$        |  | - | 10   | -    |    |
| Turn-off delay time          | $t_{d(off)}$ |  | - | 30   | -    |    |
| Fall time                    | $t_f$        |  | - | 35   | -    |    |

**Gate Charge Characteristics<sup>2)</sup>**

|                       |               |  |   |     |    |    |
|-----------------------|---------------|--|---|-----|----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=60V, I_D=120A,$<br>$V_{GS}=0$ to 10V | - | 25  | 33 | nC |
| Gate to drain charge  | $Q_{gd}$      |  | - | 15  | 30 |    |
| Gate charge total     | $Q_g$         |  | - | 70  | 95 |    |
| Gate plateau voltage  | $V_{plateau}$ |  | - | 5.2 | -  | V  |

**Reverse Diode**

|  |               |   |   |     |     |    |
|--|---------------|---|---|-----|-----|----|
| Diode continuous forward current <sup>2)</sup> | $I_S$         | $T_C=25^\circ C$                            | - | -   | 120 | A  |
| Diode pulse current <sup>2)</sup>              | $I_{S,pulse}$ |   | - | -   | 480 |    |
| Diode forward voltage                          | $V_{SD}$      | $V_{GS}=0V, I_F=100A,$<br>$T_j=25^\circ C$  | - | 0.9 | 1.3 | V  |
| Reverse recovery time <sup>2)</sup>            | $t_{rr}$      | $V_R=40V, I_F=50A,$<br>$di_F/dt=100A/\mu s$ | - | 70  | -   | ns |
| Reverse recovery charge <sup>2)</sup>          | $Q_{rr}$      |   | - | 130 | -   | nC |

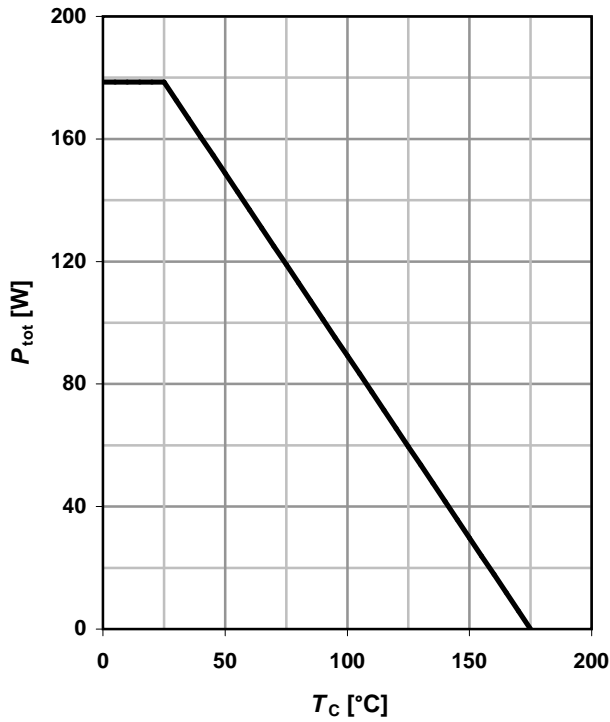
<sup>1)</sup> Current is limited by bondwire; with an  $R_{thJC} = 0.84K/W$  the chip is able to carry 149A at 25°C.

<sup>2)</sup> Specified by design. Not subject to production test.

<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

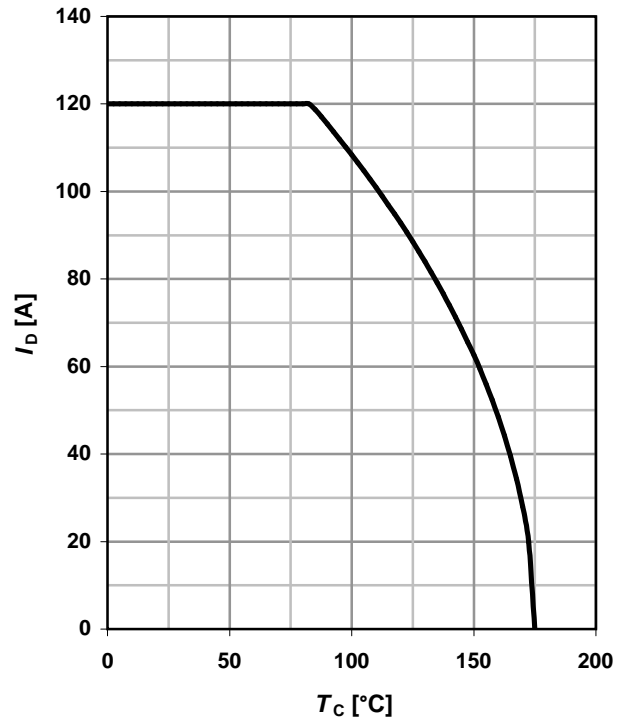
**1 Power dissipation**

$P_{tot} = f(T_C); V_{GS} \geq 6 \text{ V}$



**2 Drain current**

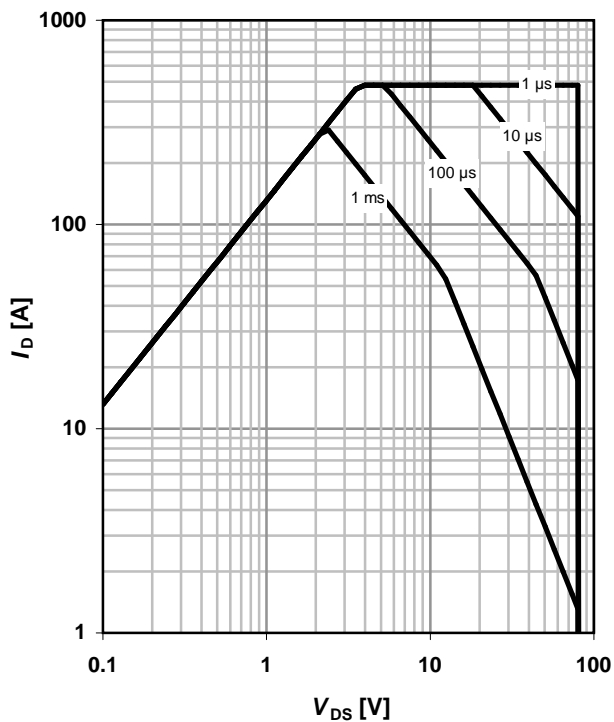
$I_D = f(T_C); V_{GS} = 10 \text{ V}; \text{SMD}$



**3 Safe operating area**

$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0; \text{SMD}$

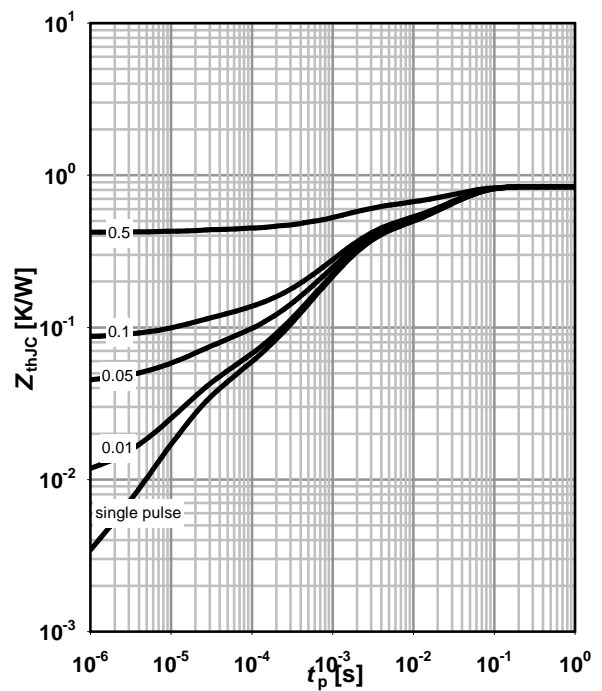
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJC} = f(t_p)$

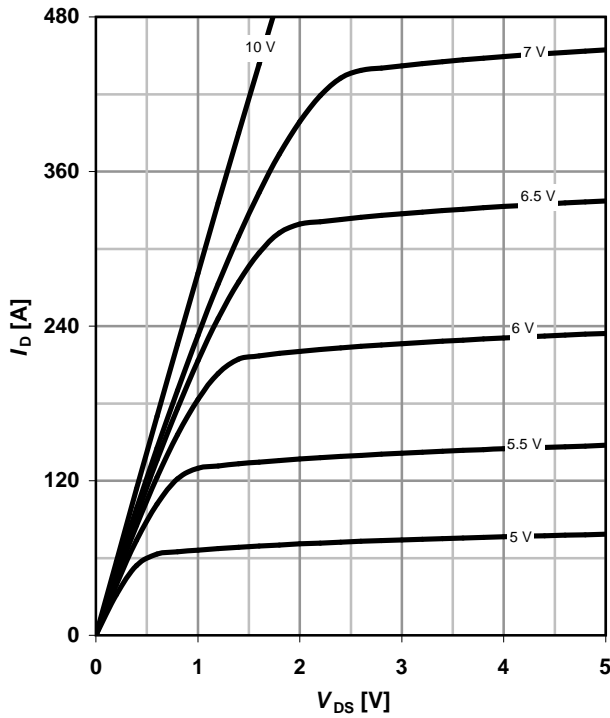
parameter:  $D = t_p/T$



**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25\text{ °C}; \text{SMD}$

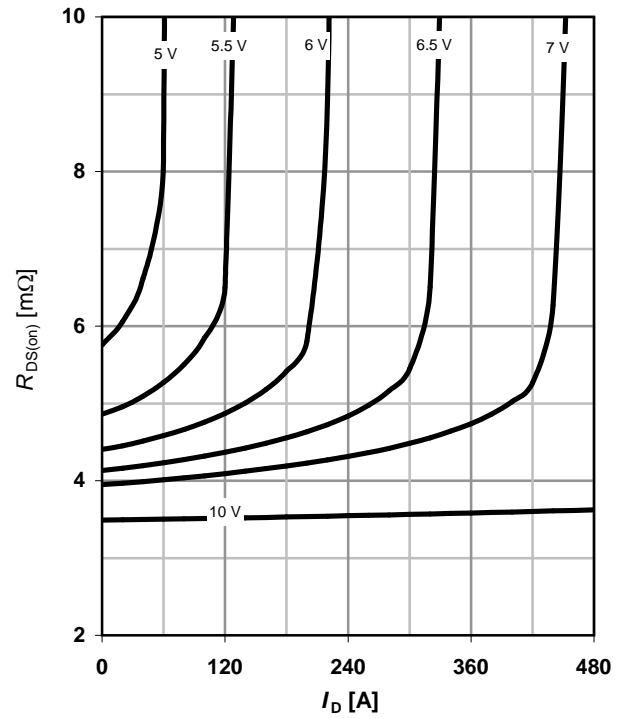
parameter:  $V_{GS}$



**6 Typ. drain-source on-state resistance**

$R_{DS(on)} = f(I_D); T_j = 25\text{ °C}; \text{SMD}$

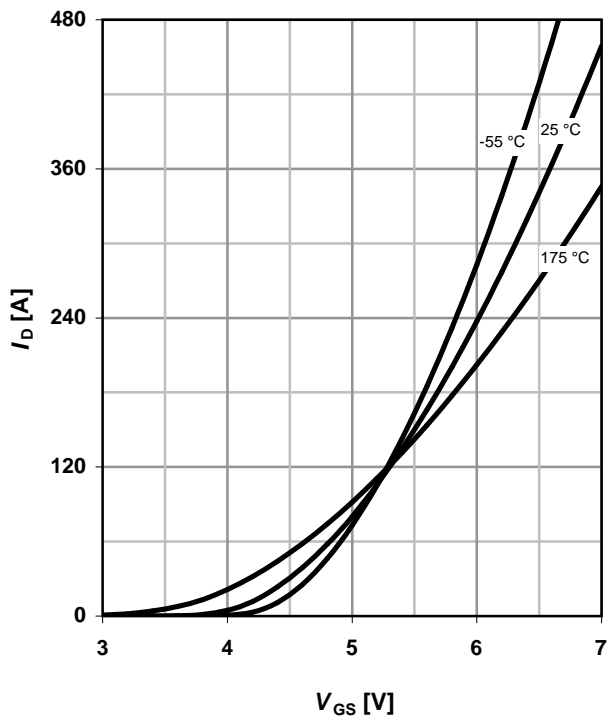
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

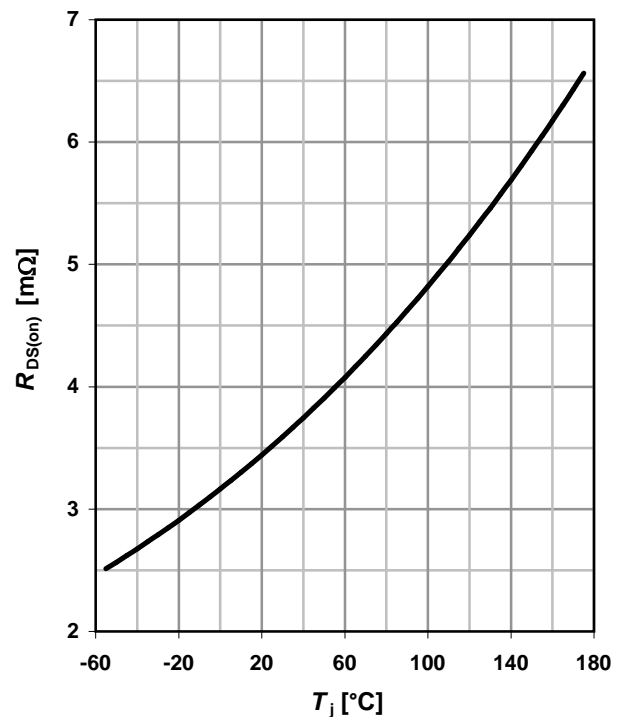
$I_D = f(V_{GS}); V_{DS} = 6\text{ V}$

parameter:  $T_j$



**8 Typ. drain-source on-state resistance**

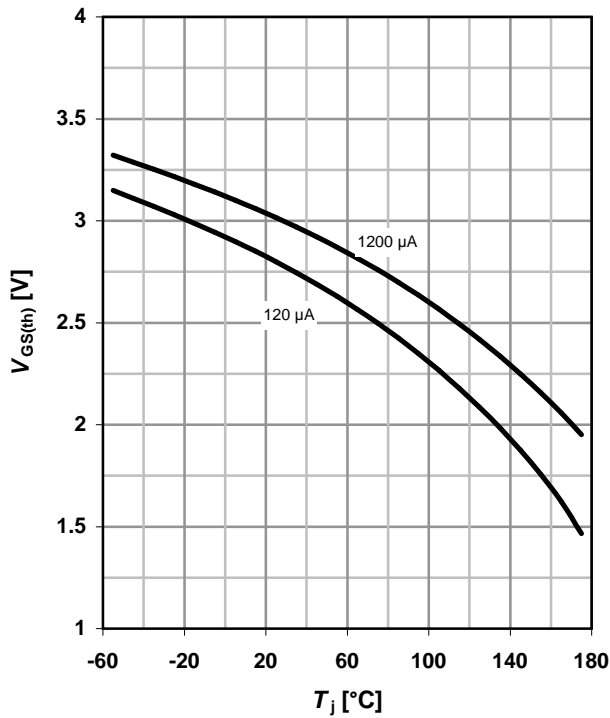
$R_{DS(on)} = f(T_j); I_D = 120\text{ A}; V_{GS} = 10\text{ V}; \text{SMD}$



**9 Typ. gate threshold voltage**

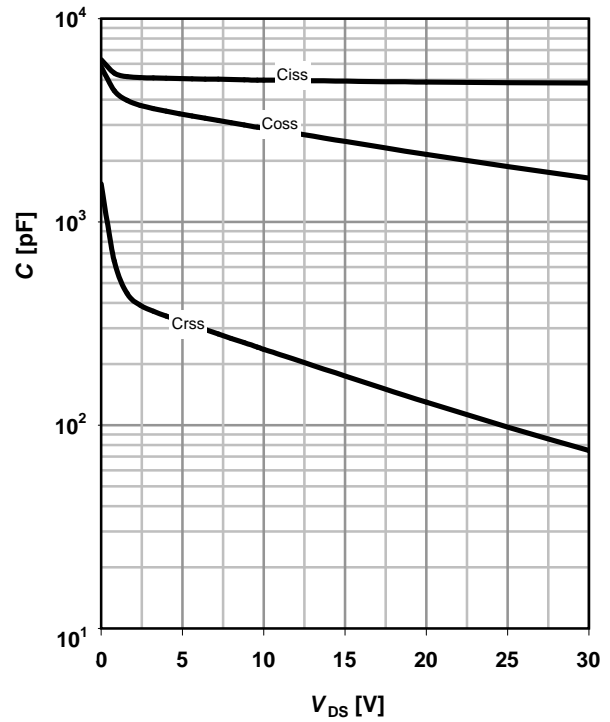
$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter:  $I_D$



**10 Typ. capacitances**

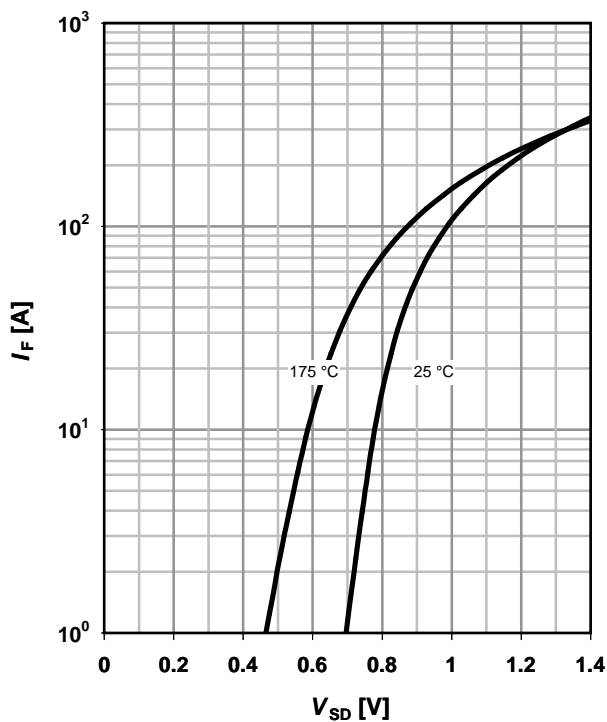
$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$



**11 Typical forward diode characteristics**

$I_F = f(V_{SD})$

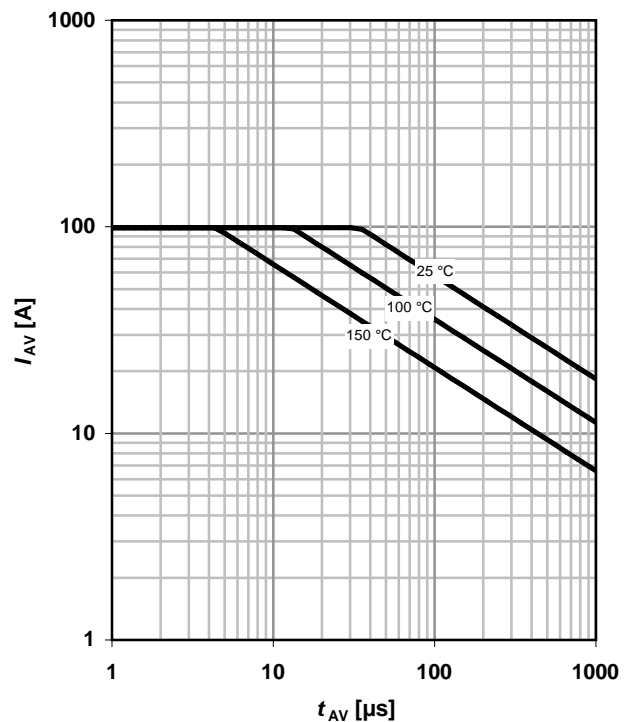
parameter:  $T_j$



**12 Avalanche characteristics**

$I_{AS} = f(t_{AV})$

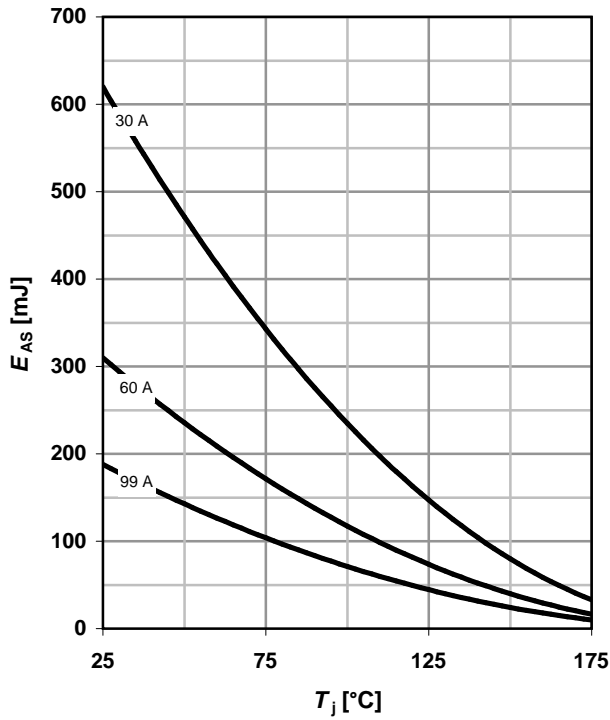
parameter:  $T_{j(start)}$



**13 Avalanche energy**

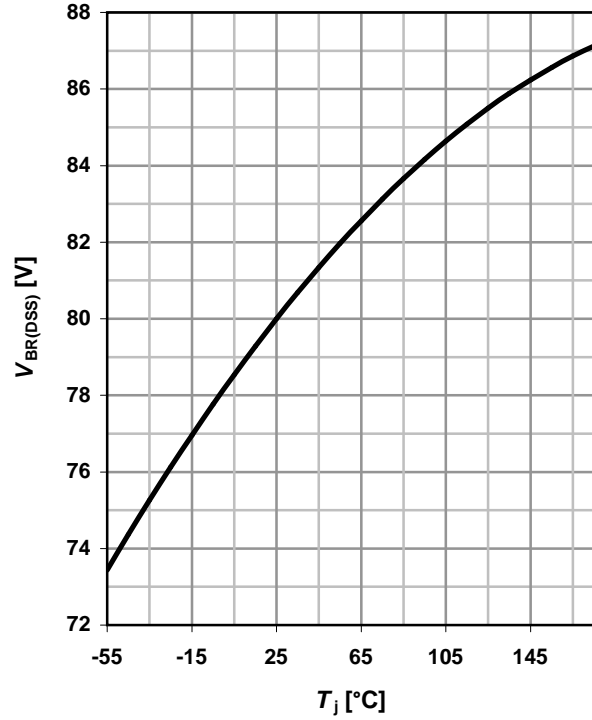
$$E_{AS} = f(T_j)$$

parameter:  $I_D$



**14 Drain-source breakdown voltage**

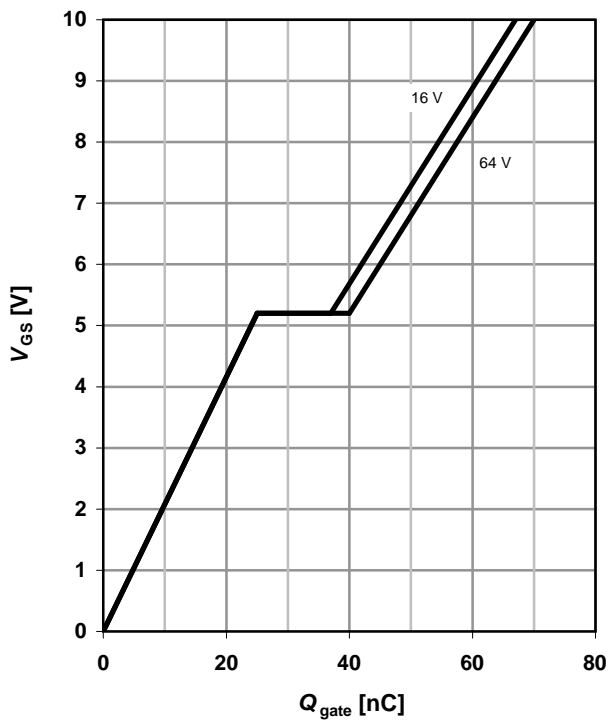
$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$



**15 Typ. gate charge**

$$V_{GS} = f(Q_{gate}); I_D = 120 \text{ A pulsed}$$

parameter:  $V_{DD}$



**16 Gate charge waveforms**



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## Revision History

| Version      | Date       | Changes          |
|--------------|------------|------------------|
| Revision 1.0 | 20.06.2014 | Final data sheet |

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